

AGENDA

ACH Committee Meeting Orlando, FL Hyatt Grand Cypress April 29, 2010

1. Call to order
2. Membership & Attendance – Introductions
3. Approval of Agenda
4. Approval of October 8, 2009 minutes
5. Correspondence
6. Report from ECA (new electronic Workspace for committees)—Ed Mikoski
7. Sub-Committee & Working Group Reports
 - 7.1 Snapshot of current projects and documents--Scott Carter
 - 7.2 Update on archival of EIA-705, EIA-726 (PN-5128) and EIA-763 (PN-5129)—Ed Mikoski
 - 7.3 Update on Polarized Component Orientation Bulletin--EIA/ECA CB21—Ed Mikoski
 - 7.4 Small Width/Pitch Task Force (PN 5081)—Discussion of IEC TC40/WG36 proposal for 4-mm wide x 1-mm pitch tapes—Charles Gutentag
 - 7.5 Split peel force—Bill Aldeen, Doug Laven
 - 7.6 ESD Task Force—James Adams
 - 7.7 Tape Splicing—TBD
 - 7.8 Tape-and-Reel Baking—James Adams
 - 7.9 ACH Knowledge Base—Bill Aldeen, James Adams, Henry Sipes
8. Guest Presentation--TBD
9. New Business
 - 8.1 Review EIA-960—Henry Sipes
 - 8.2 Review EIA-948—Nokia
 - 8.3 Cover Tape Peel Force Speed—H. Sipes
10. Old Business
 - 9.1 Strategic Planning—SWOT analysis results and follow up
 - 9.1 Marketing and new membership update—ECA website, Workshops, possible IEC TC40/WG36 joint meeting
11. Future Meeting-Place ???, Fall 2010
12. Adjournment

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